

# Commissioning of the FLASH2 Electron Beam Diagnostics in respect to its Use at the European XFEL

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International Beam Instrumentation Conference Monterey, California, USA September 14–18, 2014



#### Contents



#### > FLASH2

- New undulator beam line at FLASH
- First Beam
- > Overview of Standard Diagnostics at FLASH2
  - General characteristics
  - Electronics
  - Commissioning
- Diagnostics monitors at FLASH2
  - Charge monitors / toroids
     Toroid Protection System (TPS)
  - Screens
  - Beam Position Monitors: Cavity, Button and Stripline BPMs

#### Concluding remarks

 Beam Loss Monitors (BLM) Beam Halo Monitors

# FLASH (Free electron LASer in Hamburg)







Normal conducting 1.3 GHz RF gun

Ce2Te cathode

> Two Nd:YLF based ps photocathode lasers

- Former TTF, and VUVFEL
- Proof of principle for SASE in XUV
- > First Lasing in Feb. 2000



# **FLASH2: New Undulator Beamline**







	XFEL	FLASH
Max. energy [GeV]	17.5	1.25
Pulse repetition rate [Hz]	10	10*
Max. bunch frequency [MHz]	4.5	1
Max. pulse duration $[\mu m]$	600	800
Charge [nC]	0.02 – 1	<0.1 – 1
Photon wavelength [nm]	0.05 - 6	4.2 – 45

\* FLASH2 operates often at 1 Hz to reduce activation

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# **Overview of Standard Diagnostics at FLASH2**



- Most monitors were designed for the European XFEL
  - Make use of synergies given by the similar time line
  - Some have been designed specially for FLASH(2) or have a temporary solution
- Deliver bunch by bunch measurements, with few exceptions
- Generally based on MTCA-technology
  - Modular architecture, high availability, redundant power, well defined management.
  - 9 MTCA crates for diagnostics installed at FLASH2

#### Challenges

- MTCA previously not fully developed x2timer, power supplies
- Low charge
- Different charge for FLASH1 and FLASH2 within the same pulse
- Different rep-rate of bunch trains FLASH1 and FLASH2 (10 vs 1 Hz)

# **FLASH2** Tunnel and Technical Corridor





Electronics installed in technical corridor, parallel to tunnel

At the XFEL: everything has to be installed in the tunnel

# New Standard Diagnostics at XFEL and FLASH2



	Pipe Ø (mm)	XFEL <sup>&amp;</sup>	FLASH2 <sup>%</sup>	FLASH
Toroids	40.5 & 100	36	5	
Screens	40.5 & 96	64	7	
Screen on dump- window		3	1	
Cavity BPMs (10 mm)	10	101	17	3 (for test)
Button BPMs	10 - 96	>300#	12	4*
Stripline BPMs	34 & 44	-	4	
BLMs	-	>300	~56	
BHMs	100	4	1	1

<sup>&</sup> Also other diagnostics, not installed in FLASH2: e.g. Wire Scanners, Dosimetry monitors
 <sup>%</sup> Also other diagnostics, not XFEL-type: e.g. Ionization chambers, Cherenkov monitors
 \* With FLASH-electronics and with test-LCBPM-electronics
 # Electronics: by PSI at XFEL, by DESY at FLASH2 (LCBPM)

#### "Cold" Commissioning

- Check monitors (mostly vacuum parts):
  - e.g.: screens: motors, light; BPMs: short, symmetry
- Check cables
- Technical checks of electronics
  - Check individual components (mostly MTCA-based) and how the parts work together
  - Check availability and quality of signals needed: timing, IT
- Test servers
- Panels (!)
- Pre-calibration: either theoretical values or from lab measurements
- Commissioning with beam
  - Adjustment of trigger, clock
  - Adjustment of electronics settings
  - Calibration with beam

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# First beam in FLASH2: Preparation

#### > Beam separation seen on BPM and screen before septum



FI ASH

Free-Electron Laser in Hamburg

### **First beam in FLASH2 Extraction**





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#### > Diagnostics monitors

- Charge monitors / toroids Toroid Protection System (TPS)
- Screens
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- Concluding remarks

 Beam Loss Monitors (BLM) Beam Halo Monitors



Charge monitors / toroids

**Toroid Protection System (TPS)** 

- > Screens
- > Beam Position Monitors:
  - Cavity BPMs (CBPM)

Button and Stripline BPMs (Low Charge BPMs)

- > Beam Loss Monitors (BLM)
  - **Beam Halo Monitors**

**Ionization Chambers** 

**Cherenkov Monitors** 

- > Beam Arrival Monitors
- > Bunch Compression Monitor etc.

#### XFEL-type

# **Charge Monitors / Toroids**



#### System for the XFEL still under test

- Network of monitors to interlock on transmission and bunch pattern failure
- Noise < 1 pC</p>
- Electronics still in development

Front-End design almost ready: low-gain and high gain amplifier

- Temporary solution for FLASH2
  - Put signal from front-end electronics (low-gain only) on MTCA-ADC
  - Differential signal sent over CAT cables





M. Werner, WEPF02





# **Charge Monitors / Toroids**





Resolution measured with intermediate solution: < 1 pC rms</p>

- > Planned improvement of signal processing
  - Parabola fit
  - Correct phase of ADC sampling



# Charge Monitors: Beam Distribution to FLASH1 and FLASH2



#### Both FLASH1 and FLASH2 receiving bunches at 10 Hz

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FLASH. Free-Electron Laser

in Hamburg

# **Toroid Protection System (TPS)**





#### Screens



- Scintillator based (LYSO:Ce), spatial suppression of COTR
- > Optics:
  - Look under 45 deg
  - Uses "Scheimpflug's" principle to extend depth of field
- > 10 µm resolution required
  - single bunch, streaked
- Demonstrated at FLASH1

→ Dot Grid Target(spot Ø .50mm)
 200µm thick LYSO Screen (ON-Axis)
 → 2 half 200µm thick LYSO Screens (OFF-Axis)



C. Wiebers, IBIC2013, WEPF03

#### Screens





# **Cavity BPMs**



#### Cavities

- Dipole + reference resonator
- 3.3 GHz, low Q (about 70)
- 17 installed between undulators 10 mm pipe
- No individual tuning

#### > Readout (PSI)

- MBU (Modular BPM Unit) with 2 RFFE for 2 cavity BPMs
- Up to 4 MBUs connected to 1 DAMC2 interface board
- Timing: decoding timing protocol via fiber in MBU
- Resolution requirement
  - 2 μm rms for 0.1-1 nC and within ± 0.5 mm
     (1 μm at XFEL, but longer cables at FLASH2)

M. Stadler, WEPD12



## **Cavity BPMs: Resolution Measured**



histo residuals

- Test BPMs in FLASH1
  - 0.5 μm rms for 0.24 nC bunch charge and 0.5 mm bunch offset

#### > BPMs in FLASH2

 Difference between expected and measured position with Gaussian fit



#### **Cavity BPMs: Charge Measurement**



#### Charge resolution for 100 pC bunch charge < 0.2 pC rms</p>



#### **Button and Stripline BPMs: Overview**



#### Low Charge BPMs (LCBPM) electronics

- Name chosen in contrast to system designed for FLASH for charges of 1nC and higher
- Designed for FLASH2 (and to be installed in all FLASH)

#### S. Vilcins, TUPF11



#### **TYPICAL SIGNALS FROM BUTTON/STRIP-LINE BPM**



#### B. Lorbeer, TUPF08

# **Button and Stripline BPMs: LCBPM**



#### Front Side

FLASH.

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#### 5 BPMs/crate



Back Side



G=38dB Att.>60dB **Peak Detector** 

#### **RTM Analog Output Signals**



Crate used for the tests includes:

- management carrier hub (MCH)
- hard disk (HD), processor (CPU) •
- Digitizer SIS8300
- timing module x2timer

# **Button and Stripline BPMs: Operation**



#### Server Panel for Firmware Adjustment

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#### **BPM Expert Panel**



#### **Requirements (from XFEL requirements)**

bunch charge	0.1-1	nC
bunch spacing	≥222	ns
maximum macro-pulse repetition rate	25	Hz
beam pipe diameter	40.5	mm
single bunch resolution	50	μm
Averaged RMS resolution over 1000		
bunches of identical train	10	μm
Range for max. resolution	+/- 3	mm
Operation range with reasonable signal	+/-10	mm

#### RMS at q=36 pC, 200 pulses (incl. beam jitter)



#### **Beam Loss Monitors**



#### > Detector

- Scintillator or fused silica (rod or fiber)
- PMT: HV voltage (~500 V) generated by Cockcroft-Walton multiplier on board mounted at PMT
- Scintillators and mechanics built by IHEP, Protvino (60 for FLASH2)
- Electronics MTCA-based with low latency interface with MPS

#### > Alarms algorithms

- Single bunch
- Multi-bunch
- Integration
- OR of comparator and FPGA alarms



#### **Beam Loss Monitors: Status**







#### Calibrated single and multi-bunch alarm

Integration alarms to be calibrated

# Dump Loss Monitors: BLMs and Ionization Chambers



Similar to FLASH1: BLMs based on quarz-fiber + Ionization Chambers (air filled cables) along last 2m of beam line



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# Dump Loss Monitors: Beam Halo Monitors



#### Similar to FLASH1

#### 8 sensors:

4 Diamond + 4 Sapphire mounted behind the dump vacuum chambers

 At XFEL mounted outside chamber





FLASH1

#### A. Ignatenko, IPAC 2012, p. 816

#### Loss monitors

- Cherenkov fibers along undulators (not for XFEL)
- > Beam Compression Monitors

C. Behrens, IPAC'10, p.912

> Beam Arrival Monitors

A. Angelowski, MOPD25

> Coherent Transition Radiation monitors

S. Wesch, BIW 2012, THAP01

in Hamburg

# 1<sup>st</sup> Lasing at FLASH2





FLASH1: 250 pulses



# **Concluding Remarks**

- > XFEL and FLASH-type of diagnostics
- > Some fully commissioned:
  - Screens
- Some in advanced commissioning state; still to do (e.g.):
  - Integration alarm of BLMs
  - Implement timing coupled mode and automatic gain control for LCBPMs
  - BPM calibration
- Some have temporary solution
  - Toroid electronics and Toroid Protection System
  - MTCA power supplies
  - How components work together
- Some to be commissioned
  - Dump instrumentation

in Hamburg



The commissioning of FLASH2 paves the way for an easy(ier) commissioning of the XFEL diagnostics



M. Hüning, IPAC2013, WEZB101

# Acknowledgement



- > Many people contributed to the work and this talk
  - R. Neumann, N. Wentowski, Z. Pisarov, M. Werner, J. Lund-Nielsen, B. Lorbeer, A. Kaukher, T. Wamsat, A. Ignatenko, F. Schmidt-Föhre, K. Honkavaara, H. Tiessen, B. Michalek, R. Zahn, B. Keil, D. Nölle, O. Hensler, G. Marinkovic, K. Knaack, J. Schwarz, J. Liebing, H. Sokolinski, G. Kube, C. Wiebers, M. Felber, R. Zahn, S. Vilcins, J. Kruse, D. Renner, M. Felber, S. Schreiber, M. Holz, M. Pelzer, A. Ziegler, M. Hoeptner, H. Sokolinski, M. Stadler, I. Krouptchenkov
  - and many others
- Other Labs involved
  - PSI: Cavity BPM electronics
  - IHEP, Protvino: BLM Detectors
- Most photos by Dirk Nölle